

Surge arrester

2-electrode arrester

Series/Type: G30-A500XSMD Ordering code: B88069X2243T203

Date: 2016-04-19

Version: 02

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Surge arrester B88069X2243T203

2-electrode arrester G30-A500XSMD

Features

- Very small size
- Very fast response time
- Stable performance over life
- Very low capacitance
- High insulation resistance
- RoHS-compatible

Applications

- ESD protection
- Applications with limited space

Electrical specifications

		1	
DC spark-over voltage 1) 2)		500	V
Tolerance		±30	%
Min.		350	V
Max.		650	V
Impulse spark-over voltage			
at 100 V/µs - for 99% of measured values		< 1200	V
- typical values of distribution		< 1000	V
at 1 kV/µs - for 99% of measured values		< 1400	V
- typical values of distribution		< 1200	V
Service life 3)			
300 operations	8/20 µs	100	Α
10 operations [5x (+) & 5x (-)]	8/20 μs	1	kA
1 operation	8/20 µs	2	kA
200 operations	contact discharge 4)	500	Α
Insulation resistance at 100 V _{DC}		> 1	$G\Omega$
Capacitance at 1 MHz		< 0.5	pF
Arc voltage at 1 A		~ 10	V
Glow to arc transition current		< 1.0	Α
Glow voltage		~ 60	V
Weight		~ 0.2	g
Operation and storage temperature		-40 +125	°C
Climatic category (IEC 60068-1)		40/125/21	
Marking		without	

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

Terms in accordance with ITU-T Rec. K.12; IEC 61663-2 and IEC 61643-311.

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²⁾ In ionized mode

³⁾ Tests according to ITU-T Rec. K. 12 and UL 1449

Contact discharge parameters: 1500 pF, 10 kV, 20 Ω

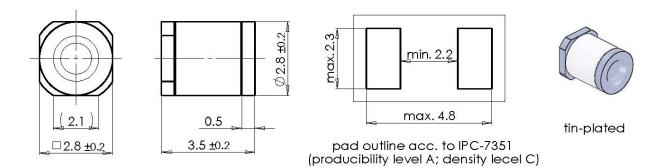


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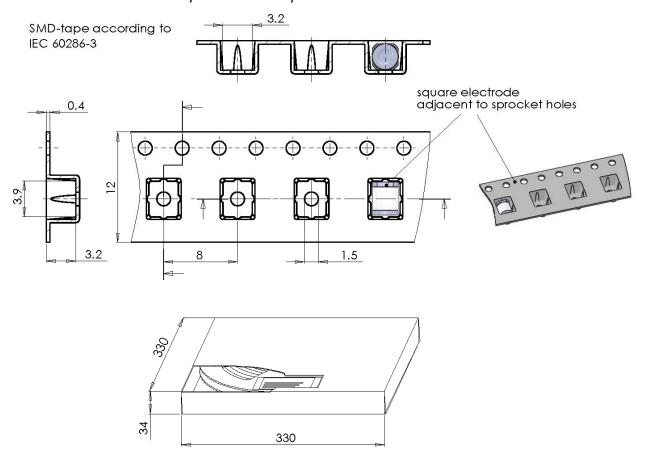
G30-A500XSMD

Dimensional drawing in mm



Ordering codes and packing advices

B88069X2243**T203** = 2000 pcs. on SMD-tape and reel



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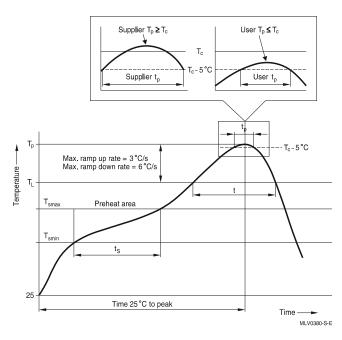
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Soldering parameter

Reflow soldering



Reflow profile features		Sn- Pb eutectic assembly	Pb-free assembly
Preheat and soak - Temperature min - Temperature max - Time	T_{smin} T_{smax} $t_{smin} \text{ to } t_{smax}$	100 °C 150 °C 60 120 s	150 °C 200 °C 60 180 s
Average ramp-up rate	T _{smax} to T _p	max. 3 °C/ s	max. 3 °C/ s
Liquidous temperature Time at liquidous	T _L	183 °C 60 150 s	217 °C 60 150 s
Peak package body temperature *, Classification temperature **	T_p,T_C	220 235 °C **	245 260 °C **
Time (t _p) ** within 5 °C of the specified classification temperature (T _C)		20 s ***	30 s ***
Average ramp-down rate	T _p to T _{smax}	max. 6 °C/ s	max. 6 °C/ s
Time 25 °C to peak temperature		max. 6 min	max. 8 min

^{* =} Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

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^{** =} For details please refer to JEDEC J-STD-020D

^{*** =} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.



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Release 2018-10